
HN62448 Series

524288-word × 16-bit/1048576-word × 8-bit CMOS Mask
Programmable ROM

HITACHI

ADE-203-397C (Z)
Rev. 3.0
Jun. 6, 1997

Description

The Hitachi HN62448 series is a 8-Mbit CMOS mask programmable ROM organized either as 524288-word × 16-bit or as 1048576-word × 8-bit. As it has realized high speed access 100 ns, it is the most suitable to the program and data memory for micro computer system. It has package variations of standard 42-pin plastic DIP, standard 44-pin plastic SOP and standard 44-pin plastic TSOPII.

Features

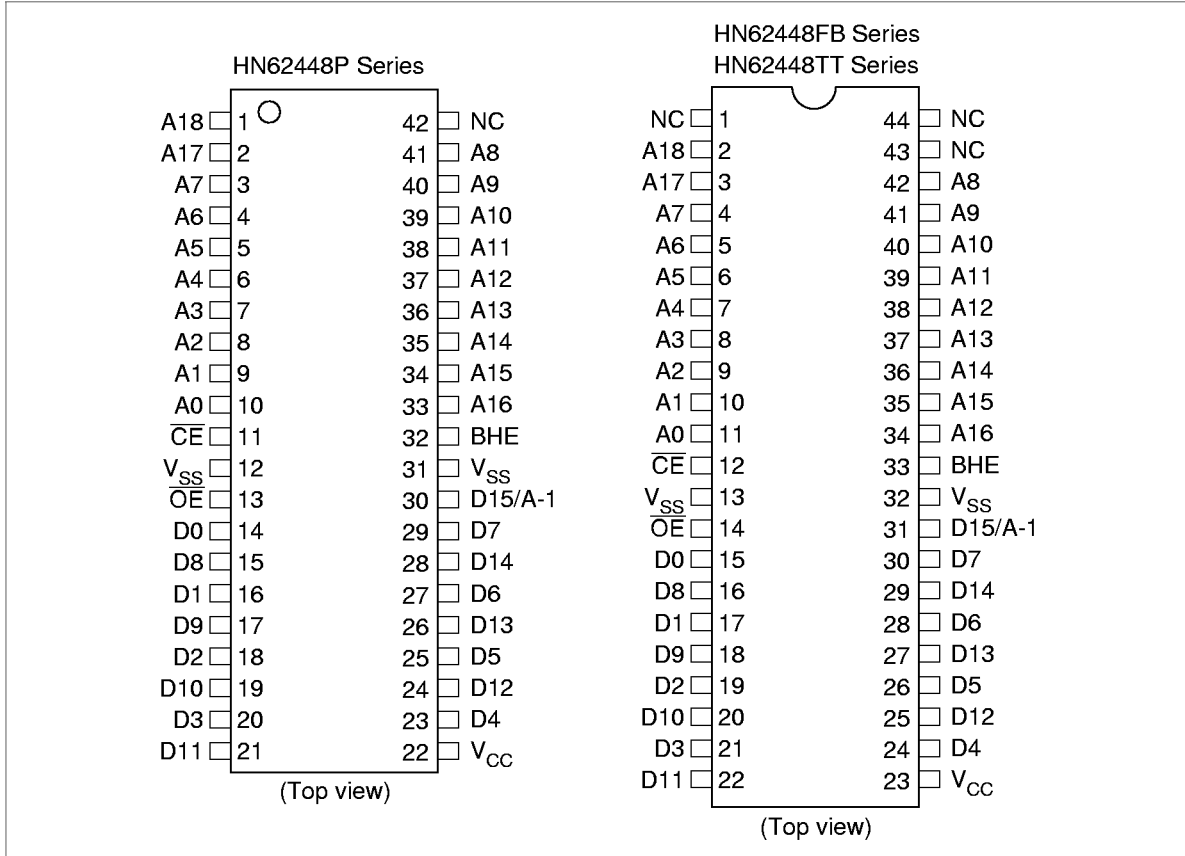
- Single 5 V supply: 5.0 V ± 10%
- Access time: 100 ns (max)
- Power dissipation
 - Active: 550 mW (max)
 - Standby: 165 μW (max)
- Byte-wide or word-wide data organization with byte/word selection (BHE)
- Three-state data output for wired or-tying
- Directly TTL compatible all inputs and outputs

Ordering Information

Type No.	Access time	Package
HN62448P-10	100 ns	600 mil 42-pin plastic DIP (DP-42)
HN62448FB-10	100 ns	600 mil 44-pin plastic SOP (FP-44D)
HN62448TT-10	100 ns	400 mil 44-pin plastic TSOPII (TTP-44D)

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Pin Arrangement

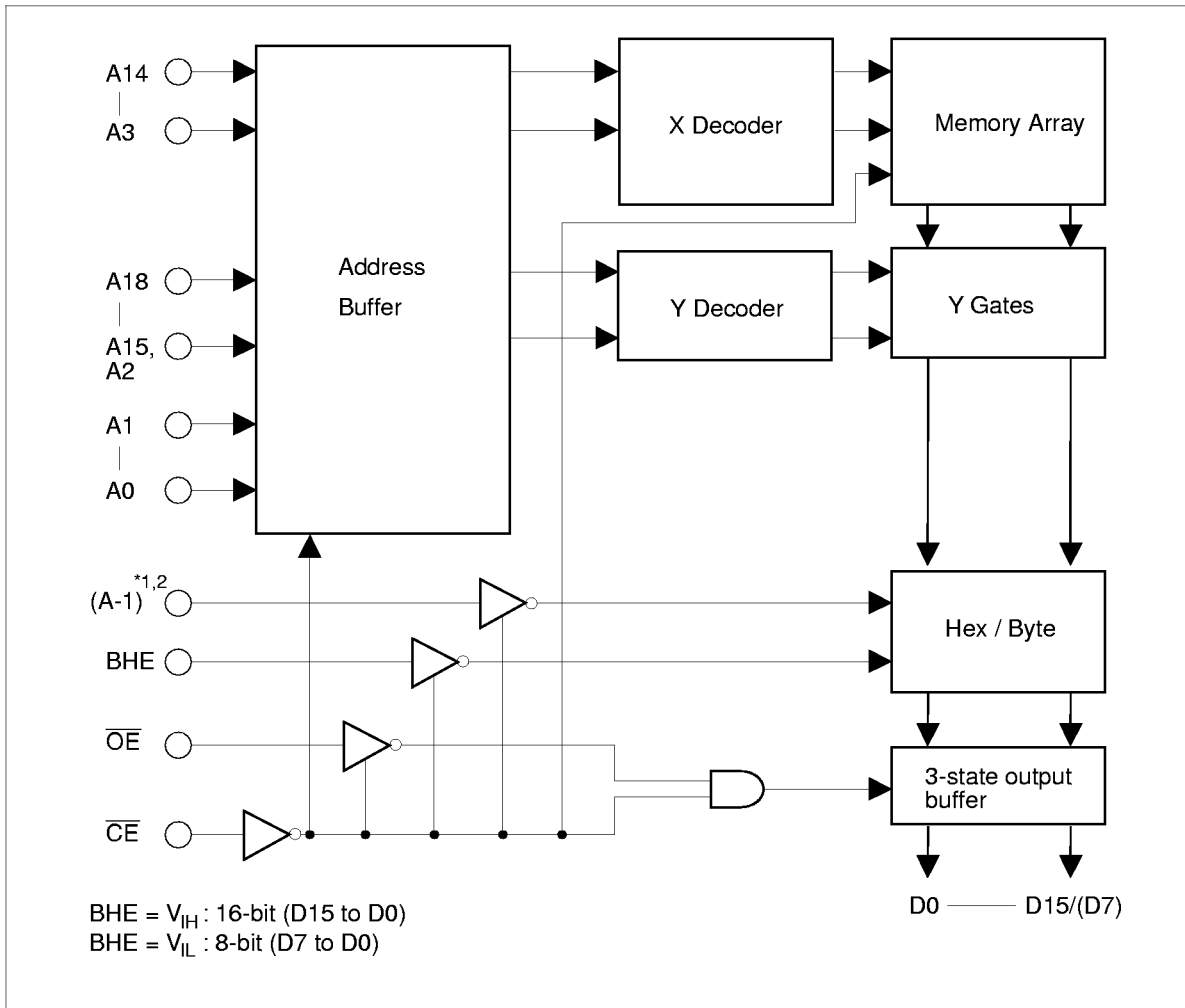


Pin Description

Pin name	Function
A-1, A0 to A18	Address input
D0 to D15	Data output
\overline{OE}	Output enable
\overline{CE}	Chip enable
BHE	Byte/word selection
V_{CC}	Power supply
V_{SS}	Ground
NC	No connection

Block Diagram

- Notes: 1. A-1 is least significant address.
 2. When BHE is 'low', D14 to D8 goes the high impedance state, and D15 should be A-1.



Operation Table

Mode	\overline{CE}	\overline{OE}	BHE	D15/A-1	Data output		Address input	
					D0-D7	D8-D15	LSB	MSB
Standby	H	\times^{*1}	\times	\times	High-Z	High-Z	—	—
Output disable	L	H	\times	\times	High-Z	High-Z	—	—
Read (16-bit)	L	L	H	Dout	D0 to D7	D8 to D15	A0	A18
Read (8-bit)	L	L	L	L	D0 to D7	High-Z	A-1	A18
Read (8-bit)	L	L	L	H	D8 to D15	High-Z	A-1	A18

Note: 1. \times : Don't care.

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Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Power supply voltage relative to V_{SS}	V_{CC}	-0.3 to +7.0	V
All input and output voltage relative to V_{SS}	V_{in} , V_{out}	-0.3 to $V_{CC} + 0.3$	V
Operating temperature range	T_{opr}	0 to +70	°C
Storage temperature range	T_{stg}	-55 to +125	°C
Temperature range under bias	T_{bias}	-20 to +85	°C

DC Operating Conditions ($T_a = 0$ to +70°C)

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	V_{CC}	4.5	5.0	5.5	V
	V_{SS}	0	0	0	V
Input high voltage	V_{IH}	2.2	—	$V_{CC} + 0.3$	V
Input low voltage	V_{IL}	-0.3	—	0.8	V

DC Characteristics ($V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $T_a = 0$ to +70°C)

Parameter	Symbol	Min	Max	Unit	Test conditions
Operating V_{CC} current	I_{CC}	—	100	mA	$V_{CC} = 5.5 \text{ V}$, $I_{DOUT} = 0 \text{ mA}$, $t_{RC} = 100 \text{ ns}$
Standby V_{CC} current	I_{SB1}	—	30	μA	$V_{CC} = 5.5 \text{ V}$, $\overline{CE} \geq V_{CC} - 0.2 \text{ V}$
	I_{SB2}	—	3	mA	$V_{CC} = 5.5 \text{ V}$, $\overline{CE} \geq 2.2 \text{ V}$
Input leakage current	$ I_{IL} $	—	10	μA	$V_{in} = 0$ to V_{CC}
Output leakage current	$ I_{OL} $	—	10	μA	$\overline{CE} = 2.2 \text{ V}$, $V_{OUT} = 0$ to V_{CC}
Output high voltage	V_{OH}	2.4	—	V	$I_{OH} = -205 \mu\text{A}$
Output low voltage	V_{OL}	—	0.4	V	$I_{OL} = 1.6 \text{ mA}$

Capacitance ($V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0 \text{ V}$, $T_a = 25^\circ\text{C}$, $V_{in} = 0 \text{ V}$, $f = 1 \text{ MHz}$)

Parameter	Symbol	Min	Max	Unit
Input capacitance	C_{in}	—	10	pF
Output capacitance	C_{out}	—	15	pF

AC Characteristics ($V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $T_a = 0\text{ to }+70^\circ\text{C}$)

- Input pulse levels: 0.4 to 2.8 V
- Input rise and fall time: 5 ns
- Input and output timing reference levels: 1.5 V
- Output load: 1TTL + $C_L = 100\text{ pF}$ (including jig)

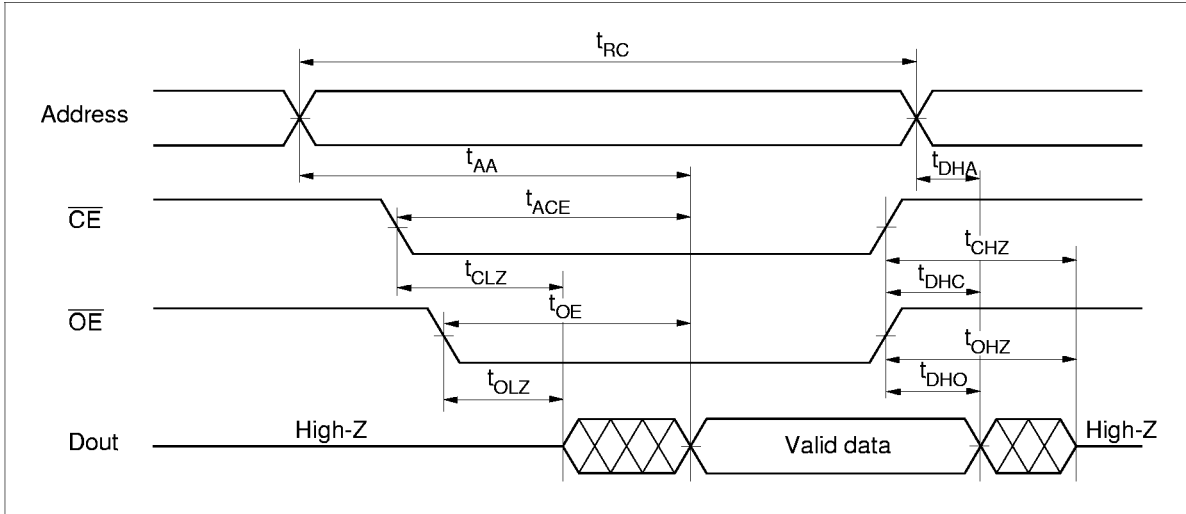
Parameter	Symbol	HN62448-10		Unit	Notes
		Min	Max		
Read cycle time	t_{RC}	100	—	ns	
Address access time	t_{AA}	—	100	ns	3
\overline{CE} access time	t_{ACE}	—	100	ns	3
\overline{OE} access time	t_{OE}	—	40	ns	3
BHE access time	t_{BHE}	—	100	ns	
Output hold time from address change	t_{DHA}	0	—	ns	2
Output hold time from \overline{CE}	t_{DHC}	0	—	ns	2
Output hold time from \overline{OE}	t_{DHO}	0	—	ns	2
Output hold time from BHE	t_{DHB}	0	—	ns	
\overline{CE} to output in high-Z	t_{CHZ}	—	40	ns	1
\overline{OE} to output in high-Z	t_{OHZ}	—	40	ns	1
BHE to output in high-Z	t_{BHZ}	—	40	ns	1
\overline{CE} to output in low-Z	t_{CLZ}	5	—	ns	4
\overline{OE} to output in low-Z	t_{OLZ}	5	—	ns	4
BHE to output in low-Z	t_{BLZ}	5	—	ns	

- Notes:
1. t_{CHZ} , t_{OHZ} and t_{BHZ} are defined as the time at which the output achieves the open circuit conditions and are not referred to output voltage levels.
 2. t_{DHA} , t_{DHC} , t_{DHO} : Determined by faster.
 3. t_{AA} , t_{ACE} , t_{OE} : Determined by slower.
 4. t_{CLZ} , t_{OLZ} : Determined by slower.
 5. \overline{CE} and \overline{OE} are enable A18 to A0 are valid.
 6. D15/A-1 pin is in the output state when BHE is high, \overline{CE} and \overline{OE} are enable. Therefore, the input signals of opposite phase to the output must be applied to them.
 7. This device is used ATD (Address Transient Detector). Therefore, transfer either \overline{CE} or address (A0 to A18) after power up to 4.5 V.

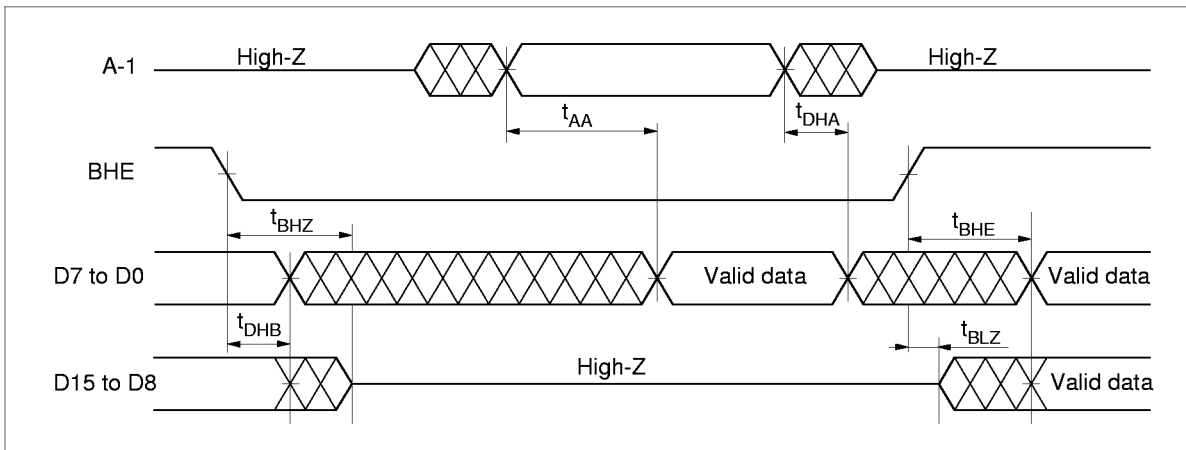
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Timing Waveforms

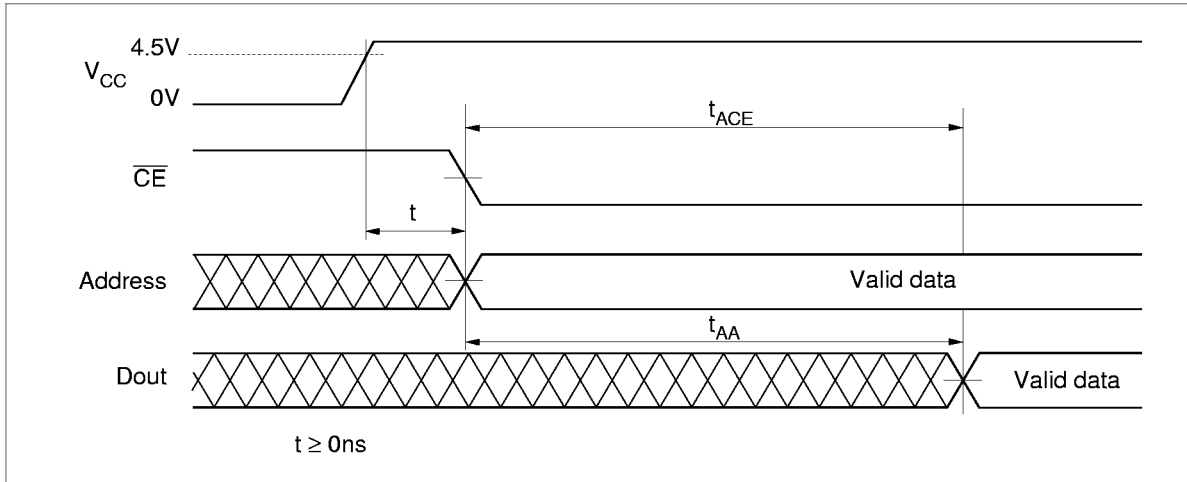
Word Mode (BHE = 'V_{IH}') or Byte Mode (BHE = 'V_{IL}')*2, 3, 4



Word Mode, Byte Mode Switch*5, 6



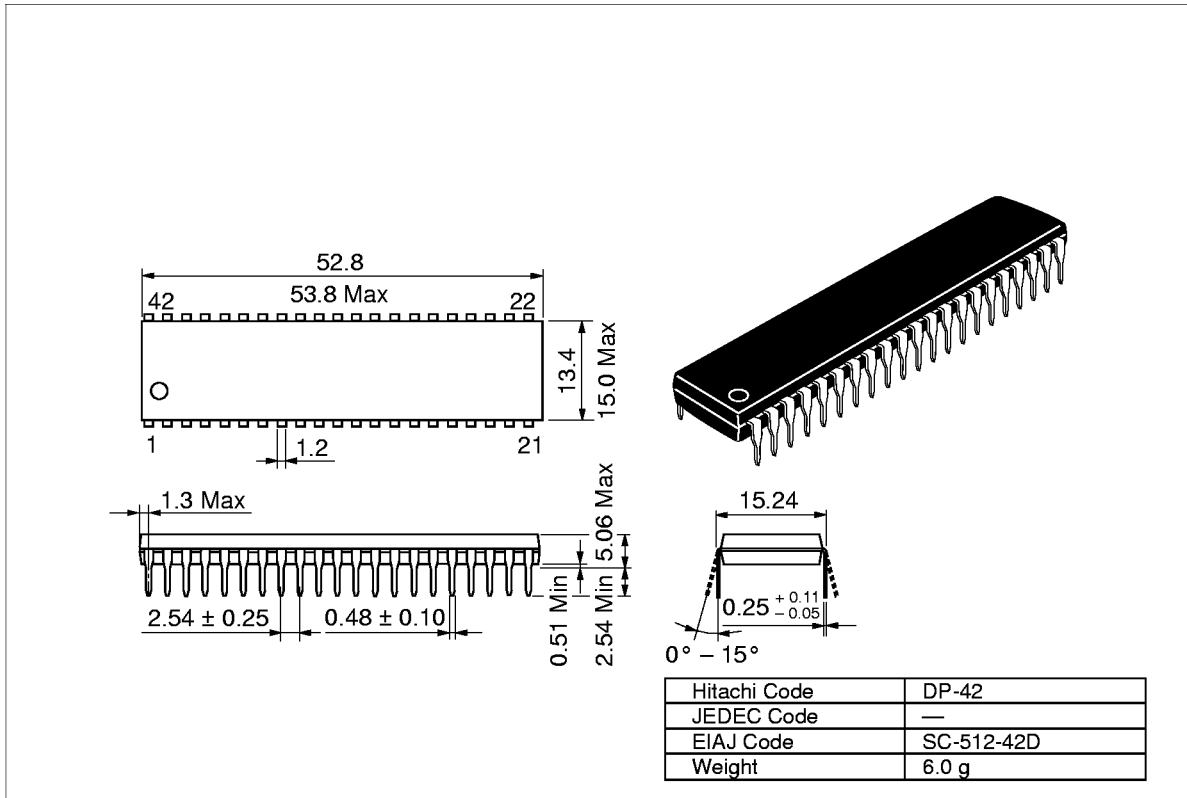
Power Up Sequence^{*7}



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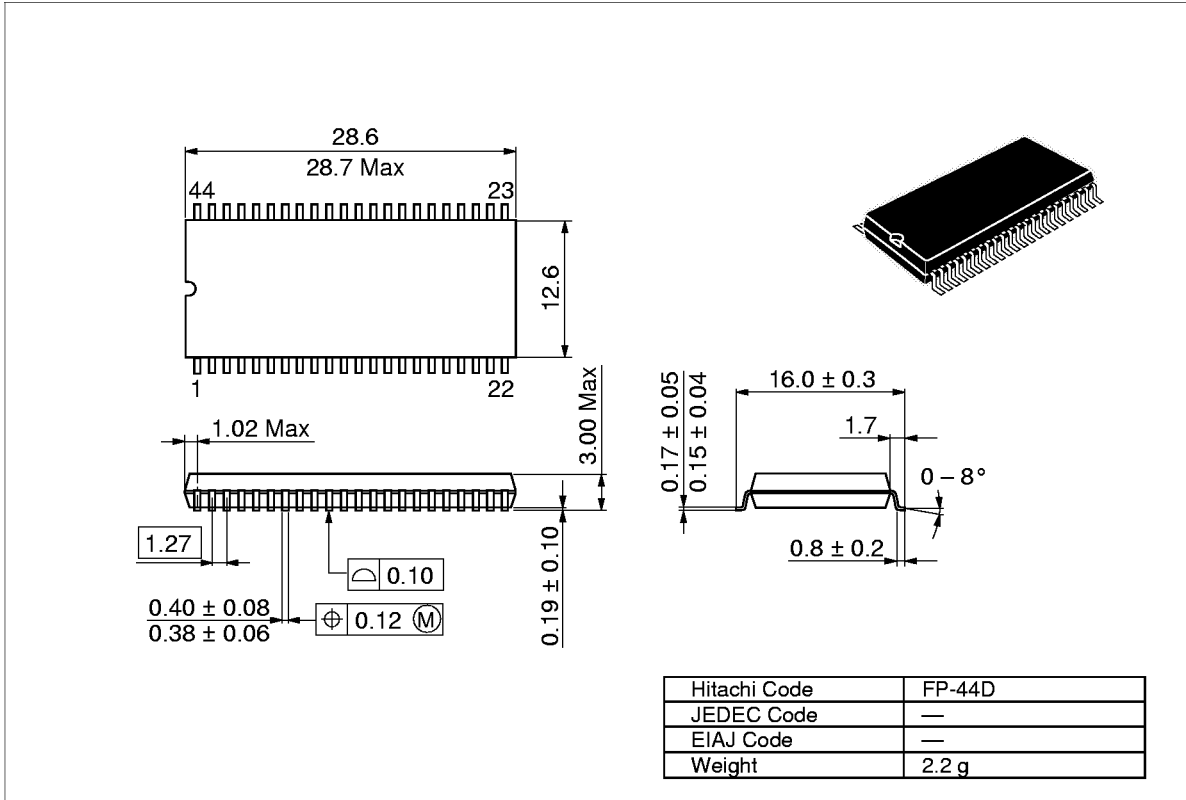
Package Dimensions

HN62448P Series (DP-42) (Unit: mm)



Package Dimensions (cont)

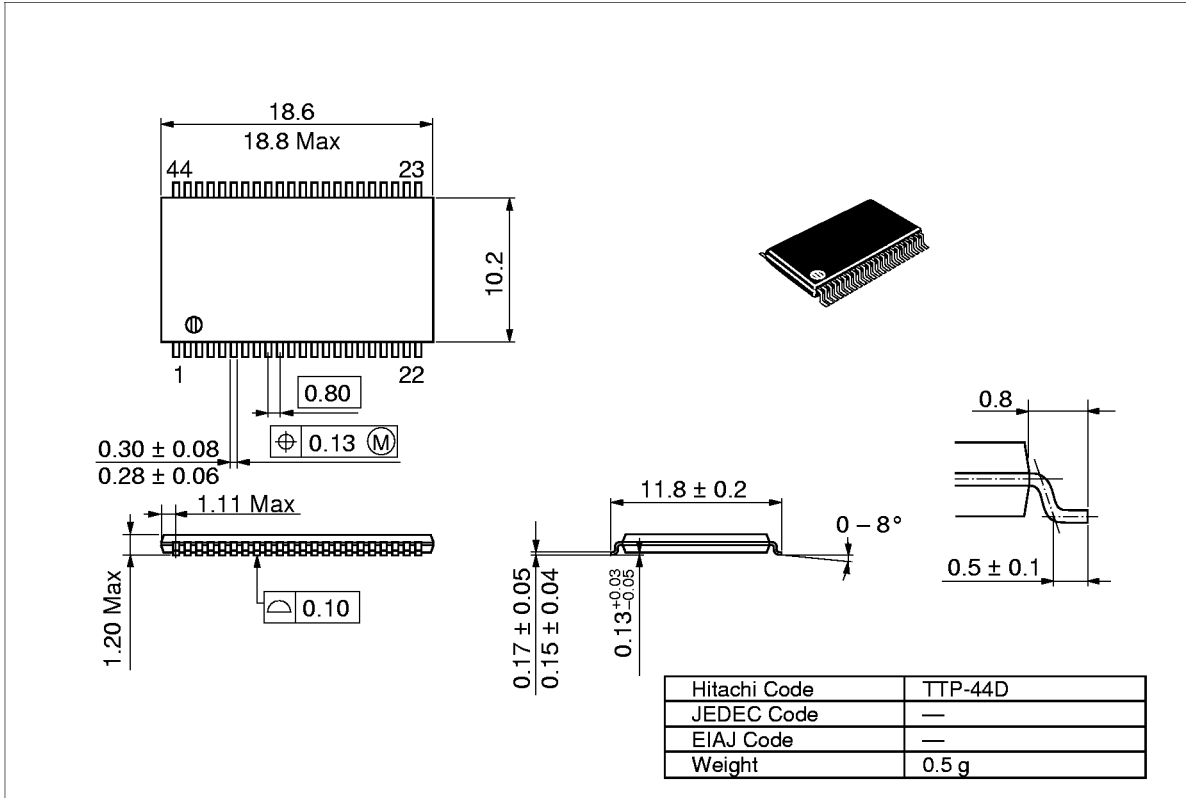
HN62448FB Series (FP-44D) (Unit: mm)



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Package Dimensions (cont)

HN62448TT Series (TTP-44D) (Unit: mm)



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Revision Record

Rev.	Date	Contents of Modification	Drawn by	Approved by
1.0	Jun. 13, 1995	Initial issue	T. Kawajiri	H. Moriuchi
2.0	Oct. 2, 1996	Change of format AC Characteristics Input pulse levels: 0.45 to 2.4 V to 0.45 to 2.8 V	A. Miyata	T. Wada
3.0	Jun. 6, 1997	Deletion of HN62448-12 Series Addition of Operation Table		
